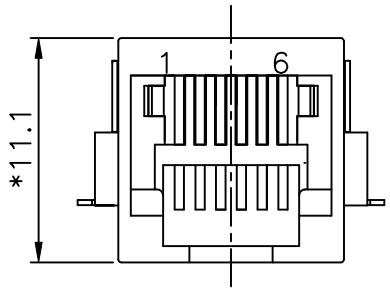
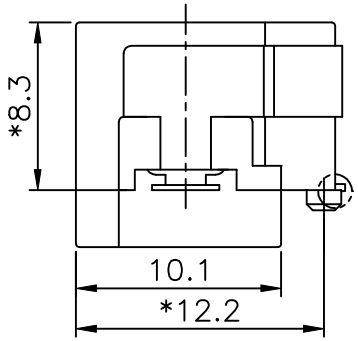
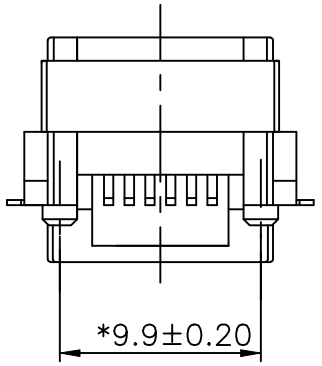
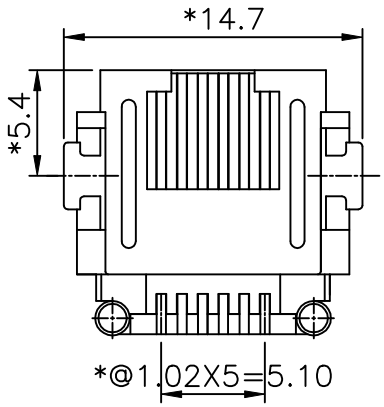
D1RFRD006

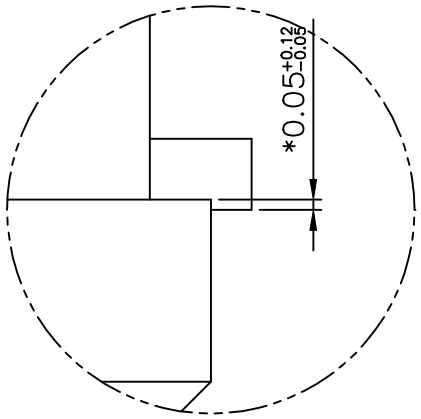
REVISION RECORD				
REV	ECO	DESCRIPTION	DRFT	CHKD



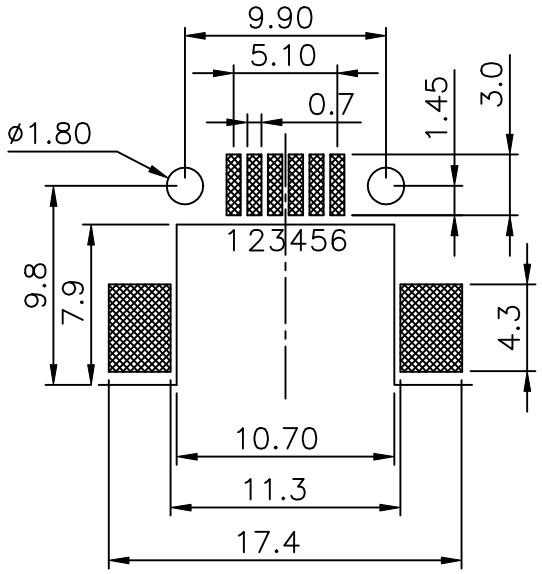








DETAIL 3:1



P.C.B. Layout (TOP VIEW) t=1

NOTES:

ELECTRICAL:

1. VOLTAGE RATING : 125 VAC RMS.
2. CURRENT RATING : 1.5 AMP.
3. CONTACT RESISTANCE : 30 MILLIOHMS MAX.
4. INSULATION RESISTANCE: 1000 MEGOHMS MIN @ 500 VDC.
5. DIELECTRIC STRENGTH : 1000 VAC RMS 60Hz, 1MIN.

MECHANICAL:

1. HOUSING MATERIAL : NYLON FR52(HIGH TEMPERTURE)
2. CONTACT MATERIAL : PHOSPHOR BRONZE t=0.35mm.
3. PLATING : 1: CONTACT AREA- SELECTIVE GOLD PLATING.
   2: TAILS- 150u" TIN-LEAD MIN OVER 50u" NICKEL.
4. OPERATING LIFE : 750 CYCLES MIN.
5. PCB RETENTION POST-SOLDER: 10 LBS MIN.

ENVIRONMENTAL:

1. STORAGE : -40°C TO +85°C.
2. OPERATION: 0°C TO 70°C.
3. REFLOW SOLDERING TEMPERTUR: 255°C TO 265°C 5-10SECOND.

MATES WITH MODULAR PLUG CONFORMING TO FCC PART 68, SUBPART F.

ROHS PART NUMBER: E666X-1X026X-L

- X: 2C-2, 4C-4, 6C-6
- X: 1-TIN, 2-NICKEL
- X: 1-3u" 2-6u" 3-15u" 4-30u" 5-50u"

MM (INCH)	DFTO SAMMY	DATE 04/11/05	FULL RISE ELECTRONIC CO., LTD
TOLERANCES EXCEPT AS NOTED	CHKD QIANPU	DATE2005/4/11	
MM .0 ±0.20 ± .00 ±0.15 ± .000 ±0.075 ±	MFO	DATE	TITLE: RJ11 SIDE ENTRY PCB JACK (SMD)
	APPV LISHENG	DATE2005/4/12	
ANGLES ±	MATERIAL :		DRAWING NO. GE663004-LA / PART NO. SEE NOTE
THIRD ANGLE PROJECTION	QT'Y :		SIZE A3 REV 0
DETACHED LISTS	FINISH :		
	SCALE :		DO NOT SCALE DRAWING SHEET X OF Y